N**ational** Semiconductor

LM10 **Operational Amplifier and Voltage Reference General Description**

The LM10 series are monolithic linear ICs consisting of a precision reference, an adjustable reference buffer and an independent, high quality op amp.

The unit can operate from a total supply voltage as low as 1.1V or as high as 40V, drawing only 270µA. A complementary output stage swings within 15 mV of the supply terminals or will deliver ±20 mA output current with ±0.4V saturation. Reference output can be as low as 200 mV.

The circuit is recommended for portable equipment and is completely specified for operation from a single power cell. In contrast, high output-drive capability, both voltage and current, along with thermal overload protection, suggest it in demanding general-purpose applications.

The device is capable of operating in a floating mode, independent of fixed supplies. It can function as a remote comparator, signal conditioner, SCR controller or transmitter for analog signals, delivering the processed signal on the same line used to supply power. It is also suited for operation in a wide range of voltage- and current-regulator applications, from low voltages to several hundred volts, providing greater precision than existing ICs.

This series is available in the three standard temperature ranges, with the commercial part having relaxed limits. In addition, a low-voltage specification (suffix "L") is available in the limited temperature ranges at a cost savings.

REFERENCE

FEEDBACK

OP AMP

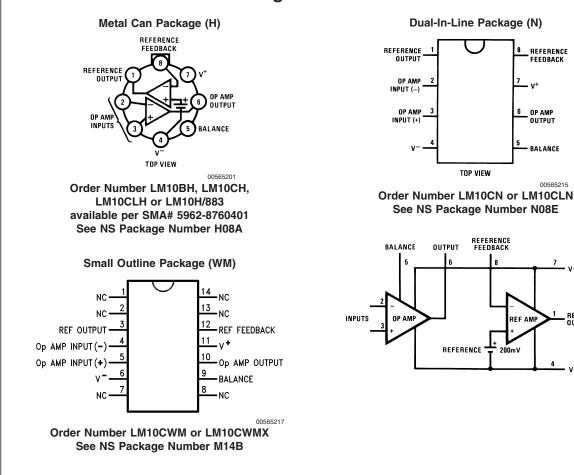
OUTPUT

BALANCE

00565215

- input offset voltage: 2.0 mV (max)
- input offset current: 0.7 nA (max)
- input bias current: 20 nA (max)
- reference regulation: 0.1% (max)
- offset voltage drift: 2µV/°C
- reference drift: 0.002%/°C

Features



Connection and Functional Diagrams

REFERENCE

Absolute Maximum Ratings (Notes 1,

8)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

	LM10/LM10B	LM10BL/
	LM10C	LM10CL
Total Supply Voltage	45V	7V
Differential Input Voltage (Note 2)	±40V	±7V
Power Dissipation (Note 3)	internally	limited
Output Short-circuit Duration (Note	e contin	uous
4)		
Storage-Temp. Range	–55°C to	+150°C
Lead Temp. (Soldering, 10 second	ds)	
Metal Can	300	°C
Lead Temp. (Soldering, 10	260	°C
seconds) DIP		
Vapor Phase (60 seconds)	215	°C
Infrared (15 seconds)	220	°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

ESD rating is to be determined.

Maximum Junction Temperature

LM10	150°C
LM10B	100°C
LM10C	85°C

Operating Ratings

Package Thermal Resistance

θ _{JA}	
H Package	150°C/W
N Package	87°C/W
WM Package	90°C/W
θ_{JC}	
H Package	45°C/W

Electrical Characteristics

T -25°C T <t <t<="" th=""><th>(Roldface type refers to lim</th><th>nits over temperature range) (Note 5)</th></t>	(Roldface type refers to lim	nits over temperature range) (Note 5)
$J = 23 O$, $MIN \ge J \ge MAX$	(Dolulace type relets to init	ins over temperature range, (Note 5)

Parameter	Conditions	LM10/LM10B			LM10C			Units
		Min	Тур	Max	Min	Тур	Max	1
Input offset voltage			0.3	2.0		0.5	4.0	mV
				3.0			5.0	mV
Input offset current			0.25	0.7		0.4	2.0	nA
(Note 6)				1.5			3.0	nA
Input bias current			10	20		12	30	nA
				30			40	nA
Input resistance		250	500		150	400		kΩ
		150			115			kΩ
Large signal voltage	$V_{S}=\pm 20V, I_{OUT}=0$	120	400		80	400		V/m\
gain	V _{OUT} =±19.95V	80			50			V/m\
	$V_{S}=\pm 20V, V_{OUT}=\pm 19.4V$	50	130		25	130		V/m\
	I _{OUT} =±20 mA (±15 mA)	20			15			V/m\
	V _S =±0.6V (0.65V) , I _{OUT} =±2 mA	1.5	3.0		1.0	3.0		V/m\
	V _{OUT} =±0.4V (±0.3V) , V _{CM} =-0.4V	0.5			0.75			V/m\
Shunt gain (Note 7)	1.2V (1.3V) ≤V _{OUT} ≤40V,	14	33		10	33		V/m\
	R _L =1.1 kΩ							
	0.1 mA≤l _{o∪T} ≤5 mA	6			6			V/m
	1.5V≤V⁺≤40V, R _L =250Ω	8	25		6	25		V/m\
	0.1 mA≤l _{o∪T} ≤20 mA	4			4			V/m\
Common-mode	–20V≤V _{CM} ≤19.15V (19V)	93	102		90	102		dB
rejection	V _S =±20V	87			87			dB
Supply-voltage	-0.2V≥V ⁻ ≥-39V	90	96		87	96		dB
rejection	V ⁺ =1.0V (1.1V)	84			84			dB
	1.0V (1.1V) ≤V ⁺ ≤39.8V	96	106		93	106		dB
	V ⁻ =-0.2V	90			90			dB
Offset voltage drift			2.0			5.0		µV/°C
Offset current drift			2.0			5.0		pA/°C
Bias current drift	T _c <100°C		60			90		pA/°C

Electrical Characteristics (Continued)

 $T_J=25^{\circ}C$, $T_{MIN} \le T_J \le T_{MAX}$ (Boldface type refers to limits over temperature range) (Note 5)

Parameter	Conditions		LM10/LM10B			LM10C		
		Min	Тур	Max	Min	Тур	Max	
Line regulation	1.2V (1.3V) ≤V _S ≤40V		0.001	0.003		0.001	0.008	%/V
	0≤I _{REF} ≤1.0 mA, V _{REF} =200 mV			0.006			0.01	%/V
Load regulation	0≤I _{REF} ≤1.0 mA		0.01	0.1		0.01	0.15	%
	V ⁺ −V _{REF} ≥1.0V (1.1V)			0.15			0.2	%
Amplifier gain	0.2V≤V _{REF} ≤35V	50	75		25	70		V/mV
		23			15			V/mV
Feedback sense		195	200	205	190	200	210	mV
voltage		194		206	189		211	mV
Feedback current			20	50		22	75	nA
				65			90	nA
Reference drift			0.002			0.003		%/°C
Supply current			270	400		300	500	μA
				500			570	μA
Supply current	1.2V (1.3V) ≤V _S ≤40V		15	75		15	75	μA
change								

Electrical Characteristics

 $T_J=25^{\circ}C$, $T_{MIN} \le T_J \le T_{MAX}$ (Boldface type refers to limits over temperature range) (Note 5)

Parameter	Conditions		LM10BL			LM10CL		
		Min	Тур	Мах	Min	Тур	Мах	1
Input offset voltage			0.3	2.0		0.5	4.0	mV
				3.0			5.0	mV
Input offset current			0.1	0.7		0.2	2.0	nA
(Note 6)				1.5			3.0	nA
Input bias current			10	20		12	30	nA
				30			40	nA
Input resistance		250	500		150	400		kΩ
		150			115			kΩ
Large signal voltage	V _S =±3.25V, I _{OUT} =0	60	300		40	300		V/mV
gain	V _{OUT} =±3.2V	40			25			V/mV
	V _S =±3.25V, I _{OUT} =10 mA	10	25		5	25		V/mV
	V _{OUT} =±2.75 V	4			3			V/mV
	V _S =±0.6V (0.65V) , I _{OUT} =±2 mA	1.5	3.0		1.0	3.0		V/mV
	V _{OUT} =±0.4V (±0.3V) , V _{CM} =-0.4V	0.5			0.75			V/mV
Shunt gain (Note 7)	1.5V≤V ⁺ ≤6.5V, R _L =500Ω	8	30		6	30		V/mV
	0.1 mA≤l _{o∪T} ≤10 mA	4			4			V/mV
Common-mode	-3.25V≤V _{CM} ≤2.4V (2.25V)	89	102		80	102		dB
rejection	V _S =±3.25V	83			74			dB
Supply-voltage	-0.2V≥V ⁻ ≥-5.4V	86	96		80	96		dB
rejection	V ⁺ =1.0V (1.2V)	80			74			dB
	1.0V (1.1V) ≤V ⁺ ≤6.3V	94	106		80	106		dB
	V ⁻ =0.2V	88			74			dB
Offset voltage drift			2.0			5.0		µV/°C
Offset current drift			2.0			5.0		pA/°C
Bias current drift			60			90		pA/°C
Line regulation	1.2V (1.3V) ≤V _S ≤6.5V		0.001	0.01		0.001	0.02	%/V
	0≤I _{BEF} ≤0.5 mA, V _{BEF} =200 mV			0.02			0.03	%/V

Electrical Characteristics (Continued)

 $_{J}$ =25°C, $T_{MIN} \leq T_{J} \leq T_{MAX}$ (Boldface type refers to limits over temperature range) (Note 5)

Parameter	Conditions	LM10B		LM10BL		LM10BL LM10CL		LM10CL		Units
		Min	Тур	Мах	Min	Тур	Max			
Load regulation	0≤I _{REF} ≤0.5 mA		0.01	0.1		0.01	0.15	%		
	V ⁺ −V _{REF} ≥1.0V (1.1V)			0.15			0.2	%		
Amplifier gain	0.2V≤V _{REF} ≤5.5V	30	70		20	70		V/mV		
		20			15			V/mV		
Feedback sense voltage		195	200	205	190	200	210	mV		
		194		206	189		211	mV		
Feedback current			20	50		22	75	nA		
				65			90	nA		
Reference drift			0.002			0.003		%/°C		
Supply current			260	400		280	500	μA		
				500			570	μA		

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 2: The Input voltage can exceed the supply voltages provided that the voltage from the input to any other terminal does not exceed the maximum differential input voltage and excess dissipation is accounted for when $V_{IN} < V^-$.

Note 3: The maximum, operating-junction temperature is 150°C for the LM10, 100°C for the LM10B(L) and 85°C for the LM10C(L). At elevated temperatures, devices must be derated based on package thermal resistance.

Note 4: Internal thermal limiting prevents excessive heating that could result in sudden failure, but the IC can be subjected to accelerated stress with a shorted output and worst-case conditions.

Note 5: These specifications apply for $V^- \le V_{CM} \le V^+ - 0.85V$ (1.0V), 1.2V (1.3V) $\le V_S \le V_{MAX}$, $V_{REF} = 0.2V$ and $0 \le I_{REF} \le 1.0$ mA, unless otherwise specified: $V_{MAX} = 40V$ for the standard part and 6.5V for the low voltage part. Normal typeface indicates 25°C limits. Boldface type indicates limits and altered test conditions for full-temperature-range operation; this is -55° C to 125° C for the LM10, -25° C to 85° C for the LM10B(L) and 0° C to 70° C for the LM10C(L). The specifications do not include the effects of thermal gradients ($\tau_1 \approx 20$ ms), die heating ($\tau_2 \approx 0.2s$) or package heating. Gradient effects are small and tend to offset the electrical error (see curves).

Note 6: For $T_J > 90^{\circ}C$, I_{OS} may exceed 1.5 nA for $V_{CM}=V^-$. With $T_J=125^{\circ}C$ and $V^- \le V_{CM} \le V^- + 0.1V$, $I_{OS} \le 5$ nA.

Note 7: This defines operation in floating applications such as the bootstrapped regulator or two-wire transmitter. Output is connected to the V⁺ terminal of the IC and input common mode is referred to V⁻ (see typical applications). Effect of larger output-voltage swings with higher load resistance can be accounted for by adding the positive-supply rejection error.

Note 8: Refer to RETS10X for LM10H military specifications.

Definition of Terms

Input offset voltage: That voltage which must be applied between the input terminals to bias the unloaded output in the linear region.

Input offset current: The difference in the currents at the input terminals when the unloaded output is in the linear region.

Input bias current: The absolute value of the average of the two input currents.

Input resistance: The ratio of the change in input voltage to the change in input current on either input with the other grounded. **Large signal voltage gain:** The ratio of the specified output voltage swing to the change in differential input voltage required to produce it.

Shunt gain: The ratio of the specified output voltage swing to the change in differential input voltage required to produce it with the output tied to the V⁺ terminal of the IC. The load and power source are connected between the V⁺ and V⁻ terminals, and input common-mode is referred to the V⁻ terminal.

Common-mode rejection: The ratio of the input voltage range to the change in offset voltage between the extremes.

Supply-voltage rejection: The ratio of the specified supply-voltage change to the change in offset voltage between the extremes.

Line regulation: The average change in reference output voltage over the specified supply voltage range.

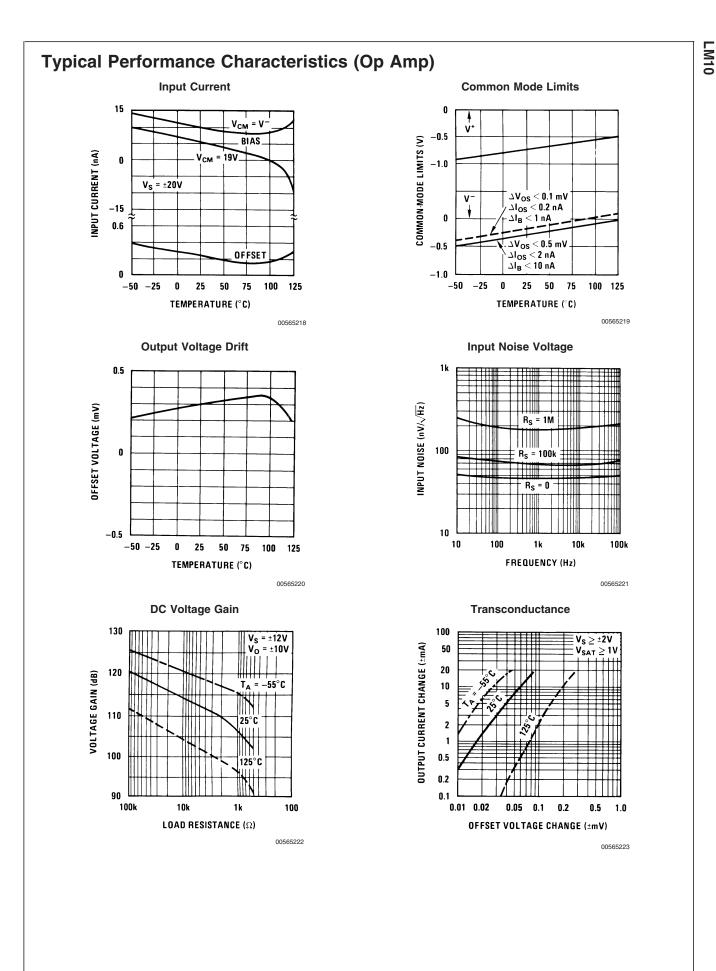
Load regulation: The change in reference output voltage from no load to that load specified.

Feedback sense voltage: The voltage, referred to V⁻, on the reference feedback terminal while operating in regulation.

Reference amplifier gain: The ratio of the specified reference output change to the change in feedback sense voltage required to produce it.

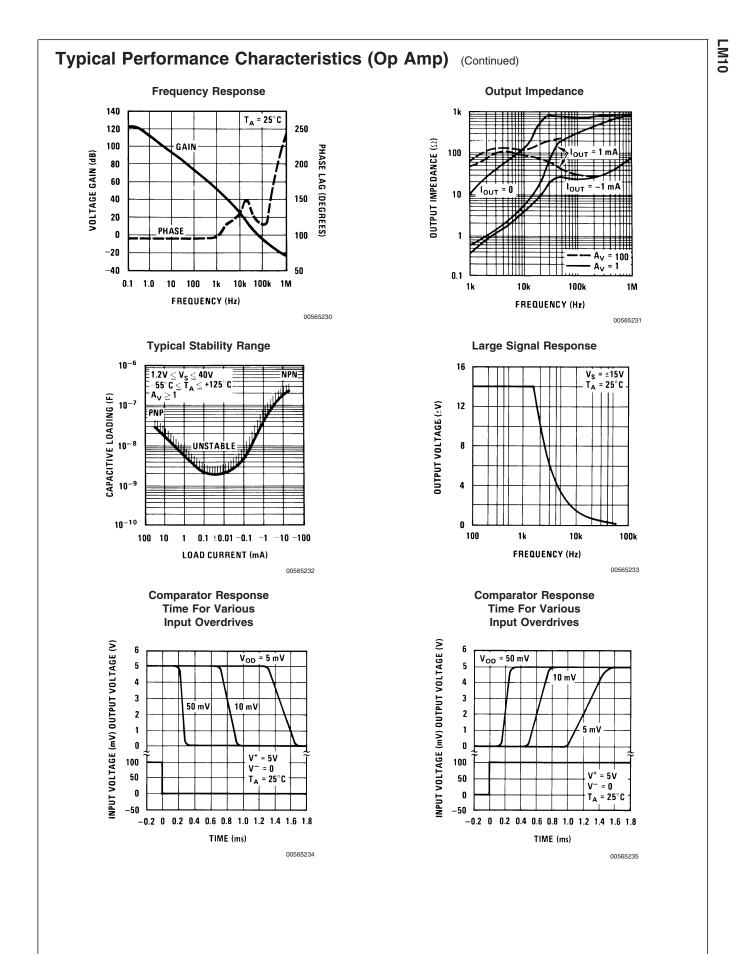
Feedback current: The absolute value of the current at the feedback terminal when operating in regulation.

Supply current: The current required from the power source to operate the amplifier and reference with their outputs unloaded and operating in the linear range.

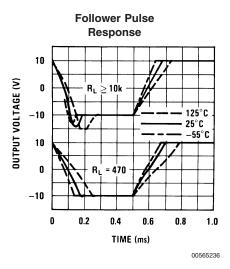




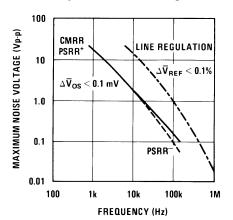
Typical Performance Characteristics (Op Amp) (Continued) **Output Saturation Output Saturation** Characteristics Characteristics 1.0 1.0 I_{OUT} = 20 mA 0.5 0.5 -20 m¦A SATURATION VOLTAGE (V) SATURATION VOLTAGE (V) 10 mA 20 10 mA 0.2 0.2 -20 m A 3 m/ 10 mA 0.1 0.1 -10 mA 'n۵ -3 'm A 0.05 0.05 -3 m A 3 m A 1 mA Λ mÁ -1 mA 0.02 -1 m A 0.02 = 0.1 mA 1 = -0.1 mA 0.01 0.01 -0.1 m/ O NPN 0.005 0.005 **NPN** - PNP 's = ±2V Ρ́ΝΡ Vs = ±2V 0.002 0.002 = 25°C $T_A = -55^{\circ}C$ n 0.001 0.001 -0.3 -0.2 -0.1 0 0.1 0.2 0.3 -0.2 -0.1 -0.3 0 0.1 0.2 0.3 **OFFSET VOLTAGE CHANGE (mV)** OFFSET VOLTAGE CHANGE (mV) 00565225 00565224 **Output Saturation** Characteristics **Minimum Supply Voltage** 1.8 1.0 20 m A NPN 0 - PNP 0.5 -20 m A TOTAL SUPPLY VOLTAGE (V) 1.6 $T_A = -55^\circ C$ SATURATION VOLTAGE (V) 0.2 '_{SAT} = 1.0V -10 mA 0.1 mÆ -1 mA 1.4 20 mA -10 mA 0.05 -3 mA 0.1 mA -20 m A 0.02 1.2 -1 mA 10 m A 0.01 NPN 0.005 10 mA 1.0 PNP 1 mA = -0.1 mA L ٧c ±2V 0.002 TA = 125°C n 0.8 0.001 0.3 0.1 0 -0.1 -0.2 0.2 1.0 -0.8 -0.6 -0.4 -0.2 0 0.2 0.4 0.6 OFFSET VOLTAGE CHANGE (mV) OFFSET VOLTAGE CHANGE (mV) 00565227 00565226 **Minimum Supply Voltage Minimum Supply Voltage** 1.8 1.8 NPN $T_A = 25^{\circ}C$ - PNP TOTAL SUPPLY VOLTAGE (V) V_{SAT} = 1.0V 20 mA TOTAL SUPPLY VOLTAGE (V) 1.6 = 125°C 1.6 NPN VSAT = 1.0V I_{OUT} = 20 mA PNPμA 1.4 -10 mA 1.4 10 m Å 20 m/ 15 mA 0 mΑ 1.2 1.2 20 m/ -10 µA -10µA 10 1.0 1.0 10 µÅ mΑ 10 mA 0.8 0.8 0.3 0.2 0.1 0 -0.1 -0.2 -0.3 1.5 1.0 0.5 0 -0.5 -1.0 -1.5 **OFFSET VOLTAGE CHANGE (mV) OFFSET VOLTAGE CHANGE (mV)** 00565228 00565229



Typical Performance Characteristics (Op Amp) (Continued)

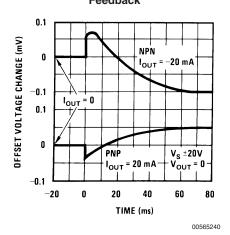


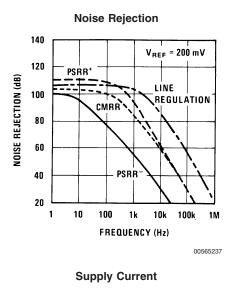


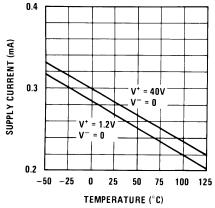






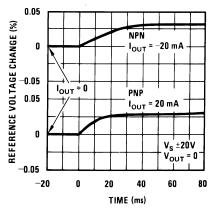


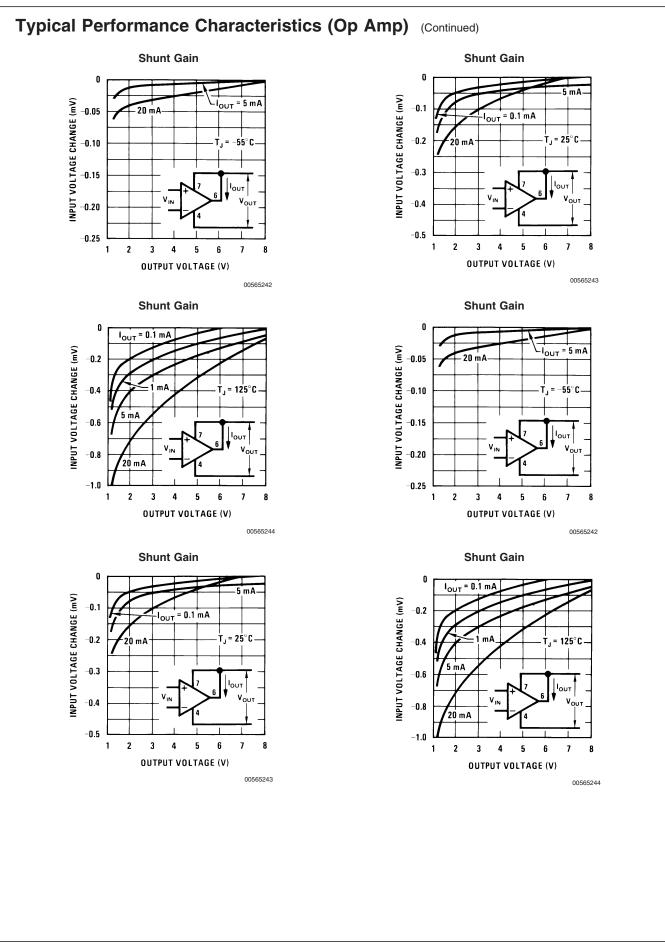




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Thermal Gradient Cross-coupling

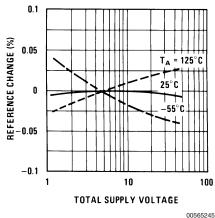




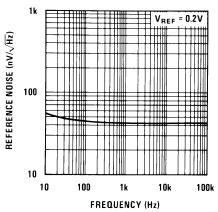


Typical Performance Characteristics (Reference)



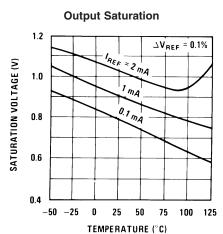


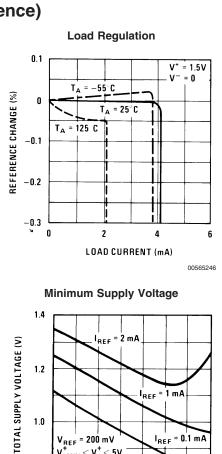


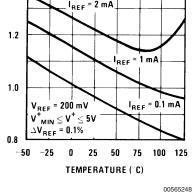


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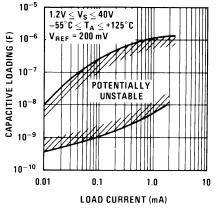
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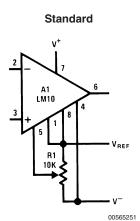


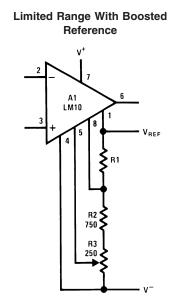


Typical Stability Range



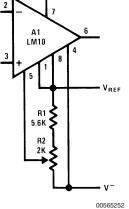
Typical Applications (Note 10) (Pin numbers are for devices in 8-pin packages) Op Amp Offset Adjustment





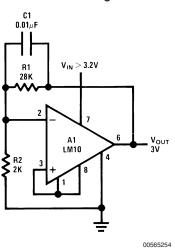
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Limited Range

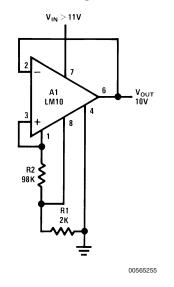




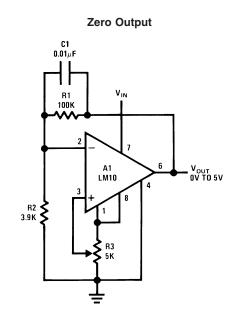
Low Voltage



Best Regulation



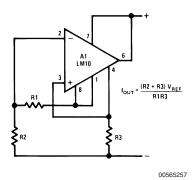




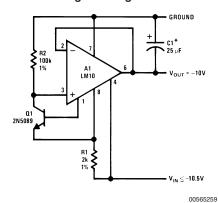


Note 9: Use only electrolytic output capacitors.



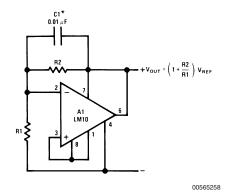


Negative Regulator



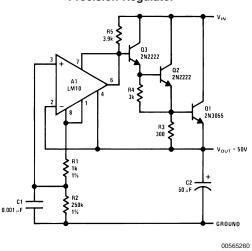


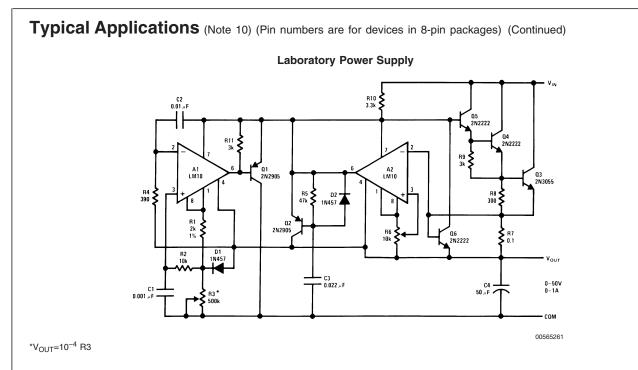
Shunt Regulator



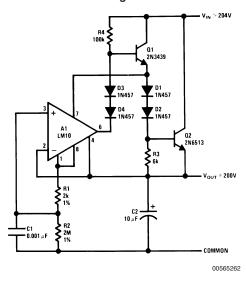
Required For Capacitive Loading



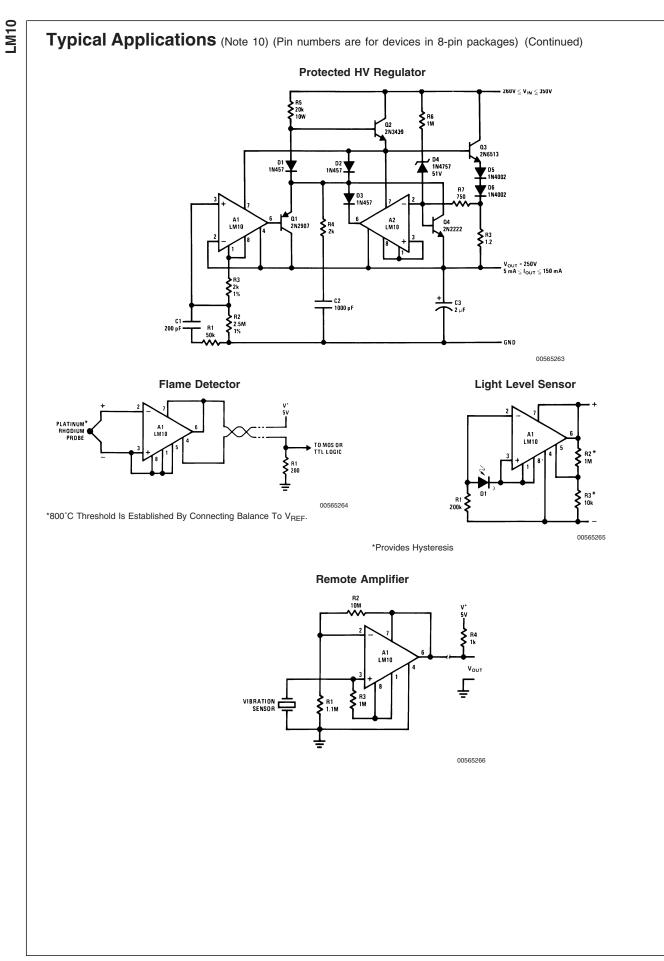


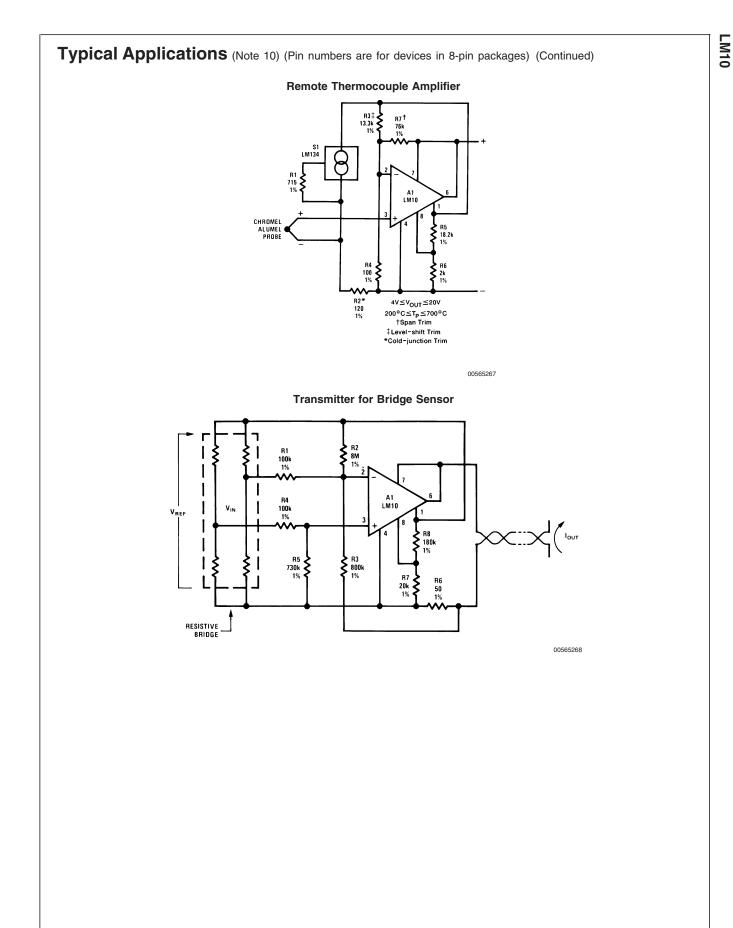






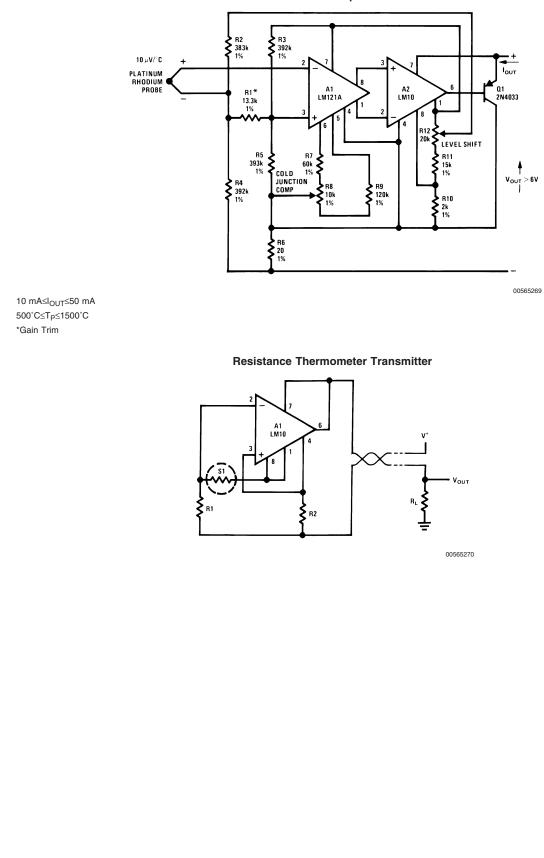
 $V_{OUT} = \frac{R2}{R1} V_{REF}$

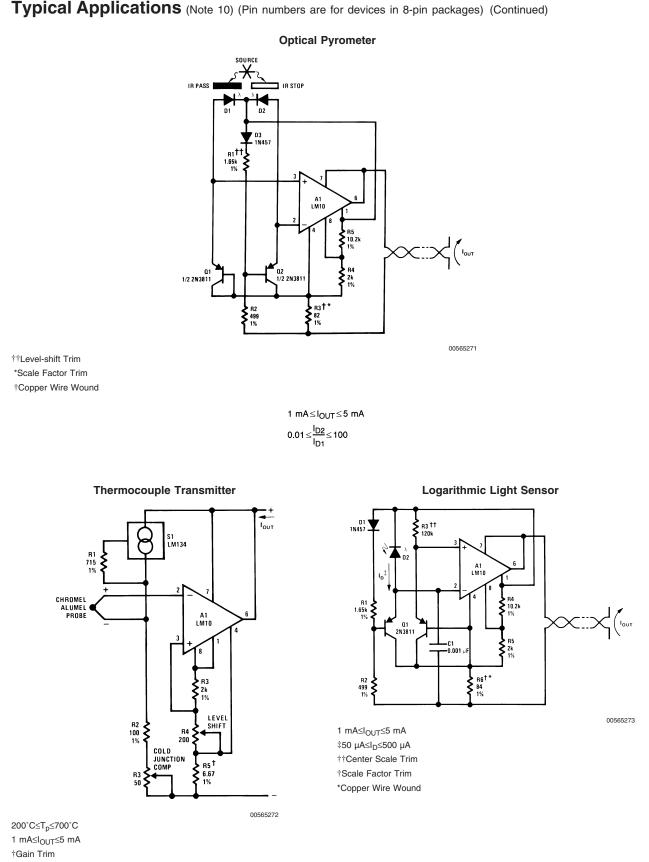




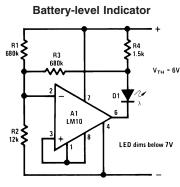
Typical Applications (Note 10) (Pin numbers are for devices in 8-pin packages) (Continued)





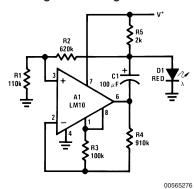


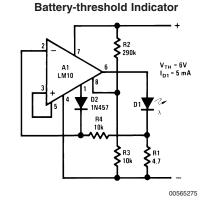




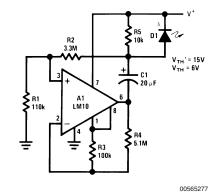


Single-cell Voltage Monitor



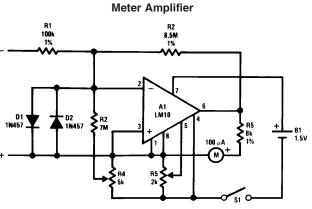


Double-ended Voltage Monitor



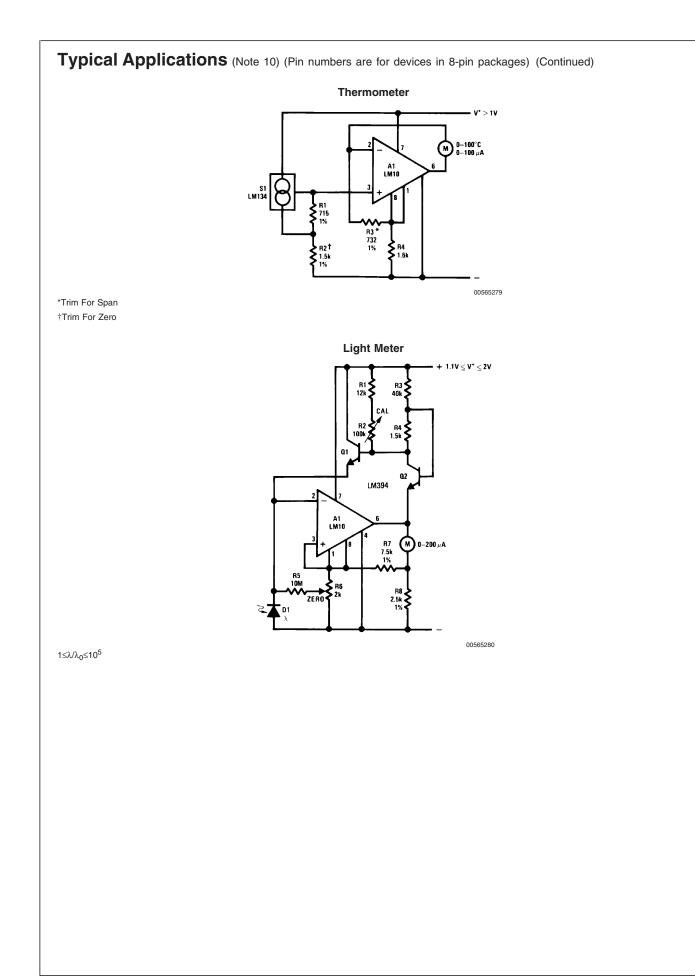
Flash Rate Increases Above 6V and Below 15V

Flashes Above 1.2V Rate Increases With Voltage



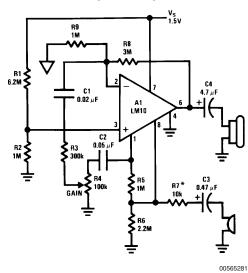
00565278

INPUT 10 mV, 100nA FULL-SCALE



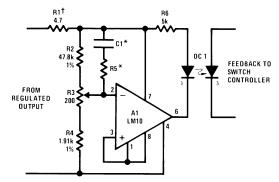
Typical Applications (Note 10) (Pin numbers are for devices in 8-pin packages) (Continued)

Microphone Amplifier



 $\begin{array}{l} Z_{OUT}\text{--}680\Omega @ 5 \text{ kHz} \\ A_V \leq 1 \text{k} \\ f_1 \text{--}100 \text{ Hz} \\ f_2 \text{--}5 \text{ kHz} \\ R_L \text{--}500 \\ \text{*Max Gain Trim} \end{array}$

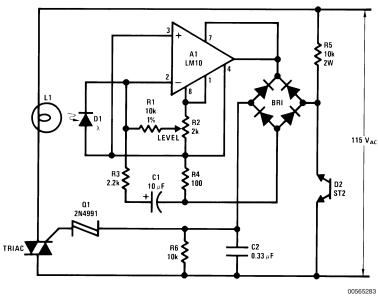




†Controls "Loop Gain"*Optional Frequency Shaping

LM10



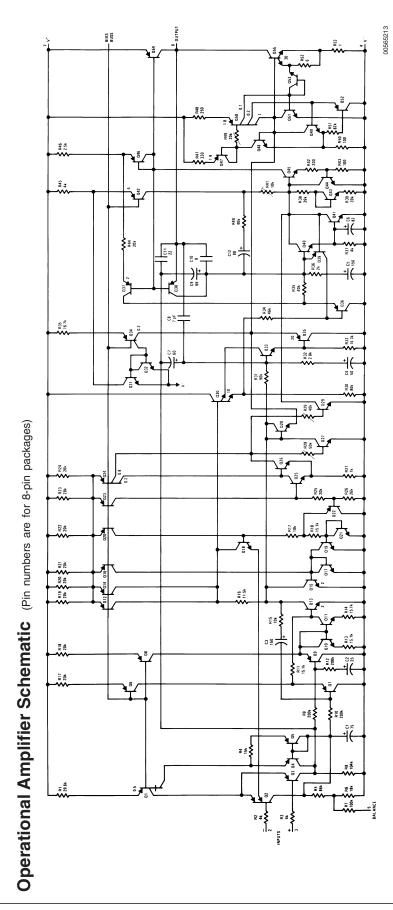


Note 10: Circuit descriptions available in application note AN-211.

Application Hints

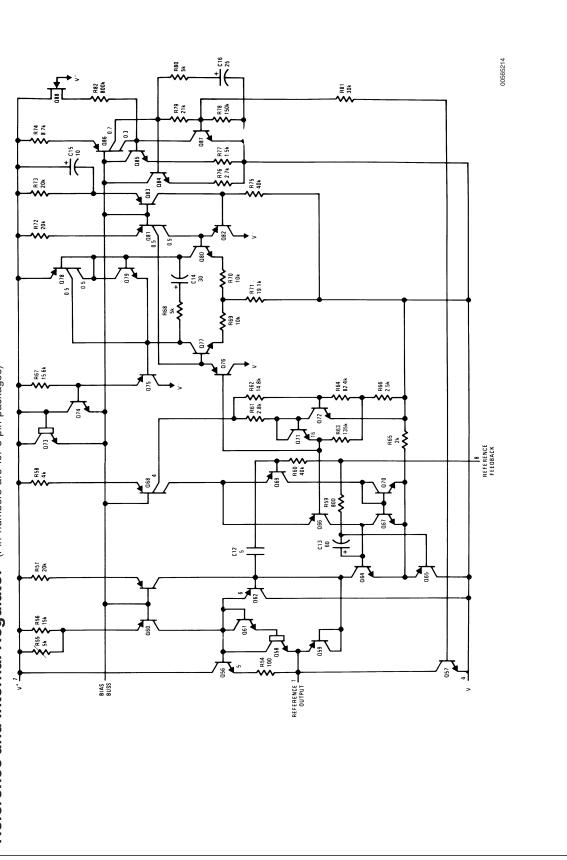
With heavy amplifier loading to V⁻, resistance drops in the V⁻ lead can adversely affect reference regulation. Lead resistance can approach 1Ω . Therefore, the common to the

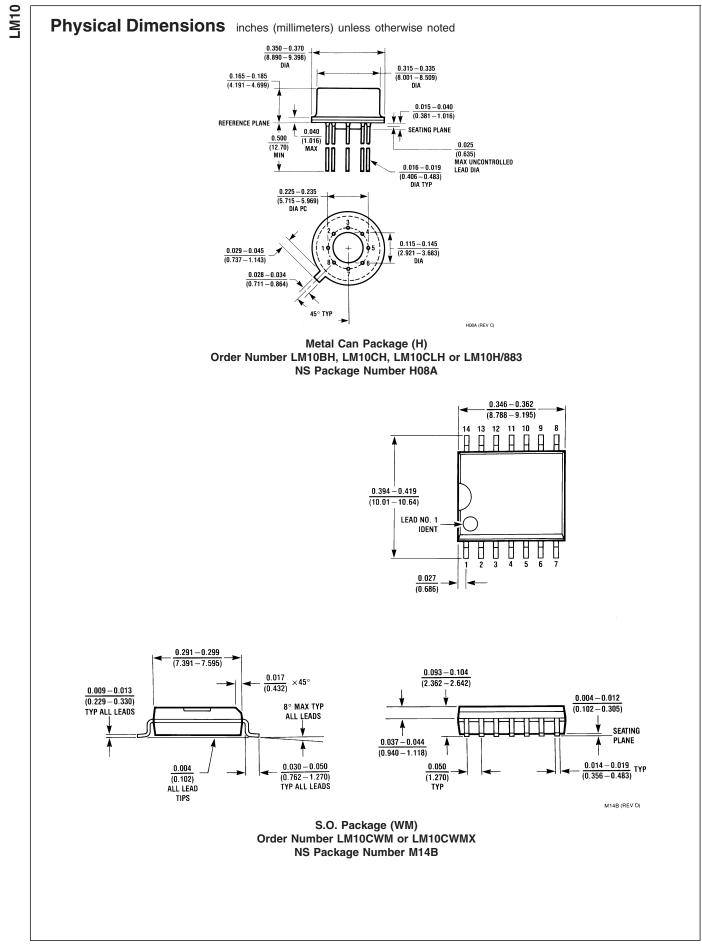
reference circuitry should be connected as close as possible to the package.

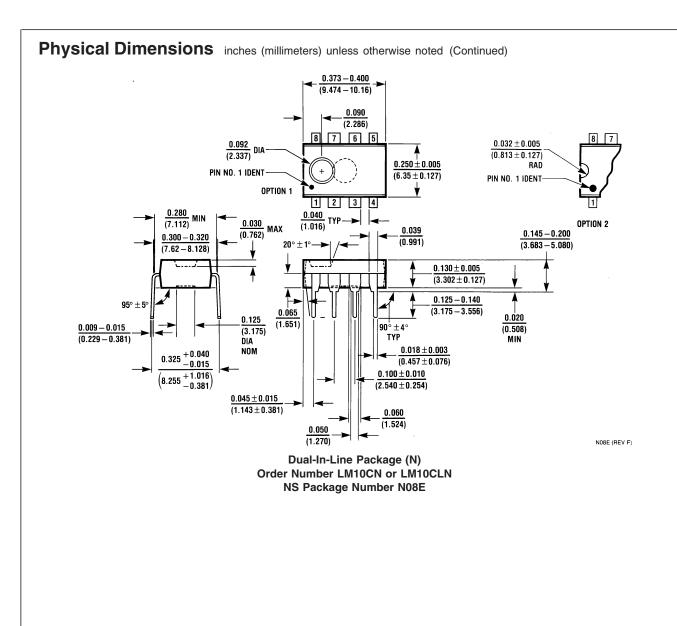




Reference and Internal Regulator (Pin numbers are for 8-pin packages)







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